- Single-Chip Interface Solution for AppleTalk[™] and LocalTalk[™]
- Designed to Operate Up To 1 Mbps In AppleTalk and LocalTalk
- Switched-Capacitor Voltage Converter Allows for Single 5-V Operation
- 4-kV ESD Protection on Bus Terminals
- Combines Multiple Components into a Single Chip Solution
- LinBiCMOS[™] Process Technology

description

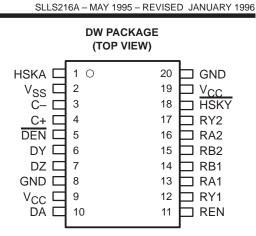
The SN75LBC775 is a low-power LinBiCMOS[™] device that incorporates the drivers and receivers for an AppleTalk or a LocalTalk interface and a switched-capacitor voltage converter for a single 5-V supply operation. LocalTalk uses a hybrid of RS-422 with the transceiver connected to the network through a small isolation transformer. The AppleTalk mode provides point-to-point communications and uses the same differential driver and receiver as LocalTalk with the addition of a hybrid RS-423, single-ended handshake driver (HSK) and receiver. In the AppleTalk mode, the port connects directly to the receiver with no isolation transformer.

While the device power is turned off ($V_{CC} = 0$) or disabled in the LocalTalk mode, the outputs are in a high-impedance state. When the driver enable (DEN) terminal is high, both the differential and serial driver outputs are in a high-impedance state.

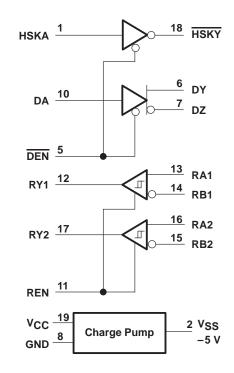
The receiver output can be disabled and becomes a high impedance when the REN terminal is low.

A switched-capacitor voltage converter generates the negative voltage required from a single 5-V supply using two 22- μ F capacitors. One capacitor is between the C+ and C- terminals and the second is between V_{SS} and ground.

The SN75LBC775 is characterized for operating over the temperature range of 0°C to 70°C.



functional diagram





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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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SN75LBC775 SINGLE-CHIP APPLETALKTM AND LOCALTALKTM TRANSCEIVER

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INF	TUT	ENABLE	(Ουτρι	JT
DA	HSKA	DEN	Α	В	HSKY
Н	Х	L	Н	L	Х
L	Х	L	L	Н	Х
Х	н	L	Х	Х	L H
Х	L	L	Х	Х	
OPEN	OPEN	L	н	L	L
х	х	н	z	Z	Z
х	х	OPEN	Z	Z	Z
H = high le	vel, L	= low level,	Х	= irrele	evant,

DRIVER FUNCTION TABLE

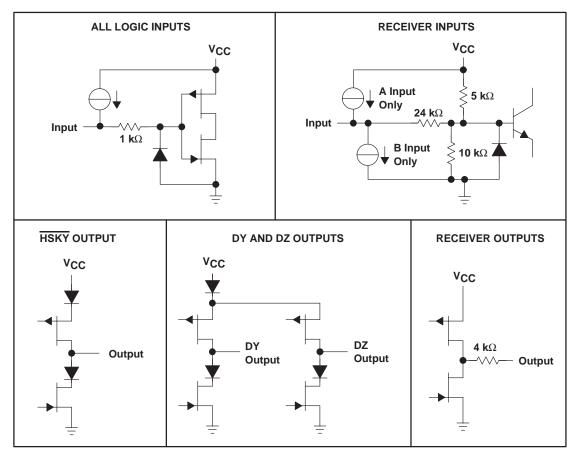
RECEIVER FUNCTION TABLE

INPUT	ENABLE	OUTPUT
RA RB	REN	RY
H L	Н	Н
LH	Н	L
OPEN	н	н
SHORT [†]	Н	?
х	L	Z

 $1 - 0.2 V < V_{ID} < 0.2 V$

Z = high impedance (off) ? = indeterminate,

schematics of inputs and outputs





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC} (see Note 1)		–0.5 to 7 V
Supply voltage range, V _{SS}		7 to 0.5 V
Receiver input voltage range, VI (RA)		–15 V to 15 V
Receiver differential input voltage range,	, V _{ID}	–12 V to 12 V
Receiver output voltage range, VO (RY)		0.5 V to 5.5 V
Driver output voltage range, VO (Pow	ver Off) (DY, DZ, HSKY)	–15 V to 15 V
		–11 V to 11 V
Driver input voltage range, VI (DA, HSKA	A, <u>DEN</u> , REN)	-0.5 V to V _{CC} + 0.4 V
Electrostatic discharge (see Note 2)	Class 3, A: Bus terminals	4 kV
	All other terminals .	2 kV
Continuous total power dissipation		See Dissipation Rating Table
Operating free-air temperature range, TA		0°C to 70°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to network ground terminal unless otherwise noted.

2. This maximum rating is tested according to MIL-STD-883C, Method 3015.7.

DISSIPATION RATING TABLE

PACKAGE	T _A ≤ 25°C	DERATING FACTOR	T _A = 85°C
	POWER RATING	ABOVE T _A = 25°C	POWER RATING
DW	1125 mW	9.0 mW/°C	585 mW

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.75	5	5.25	V
High-level input voltage, VIH	DA, HSKA, <u>DEN</u> , REN	2			V
Low-level input voltage, VIL	DA, HSKA, <u>DEN</u> , REN			0.8	V
Receiver input common-mode voltage range, VICR [‡]				7	V
Differential input voltage, VID [‡]	Differential input voltage, V _{ID} \ddagger				V
Voltage-converter filter capacitance		22			μF
Voltage-converter filter-capacitor equivalent series resistance (ESR)				2	Ω
Operating free-air temperature, TA		0		70	°C

[‡]The algebraic convention, in which the less-positive (more negative) limit is designated minimum, is used in this data sheet.



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DRIVER

electrical characteristics over recommend operating characteristics (unless otherwise noted)

	PARAMETE	R	TEST CO	NDITIONS	MIN	түр†	MAX	UNIT
VOH	High-level output voltage	Single ended	$R_1 = 3 k\Omega$, See Figure 1		3.7			V
VOL	Low-level output voltage	Single ended	$R_L = 3 k\Omega$,	See Figure 1			-3.7	V
V _{OD}	Magnitude of differential out	put voltage (V _{DY} – V _{DZ})	See Figure 2		4.0	5.6		V
$\Delta V_{OD} $	Change in differential voltag	e magnitude	See Figure 2			10	250	mV
VOC	Common-mode output volta	ge‡	See Figure 3		-1		3	V
$\Delta VOC(SS)$	Change in steady-state com	imon-mode output voltage	See Figure 3				±200	mV
I _{OZ}	High-impedance output curr	ent	$V_{CC} = 0, -10 V$	$V \le V_{O} \le 10 V$			±100	μΑ
los	Short-circuit output current		$-5 V \le V_O \le 5 V_O$	V			450	mA
ICC	Supply current		DEN at 0 V, No load	REN at 5 V,		5	10	mA
IIH	High-level input current	V _I = 5 V				200	μA	
lu.	All terminals except REN		V/- 0			-100	-200	μA
ΙL	low-level input current	REN	$V_{I} = 0$			-300	-455	μA

[†] All typical values are at V_{CC} = 5 V and T_A = 25°C.

[‡]The algebraic convention, in which the less positive (more negative) limit is designated minimum, is used in this data sheet.

switching characteristics over recommend operating conditions (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
4	Dreponstion delay time, high, to law level	Single ended			155	300	ns
^t PHL	Propagation delay time, high- to low-level	Differential			115	180	ns
	Propagation dology time, low, to high logol	Single ended			140	300	ns
^t PLH	Propagation delay time, low- to high-level	Differential			115	180	ns
t _{PZL}	Propagation delay time, high-impedance to low	elay time, high-impedance to low-level output				250	ns
^t PZH	Propagation delay time, high-impedance to high			100	250	ns	
tPLZ	Propagation delay time, low-level to high-impe	See Figuree 1 and 2		100	250	ns	
tPHZ	Propagation delay time, high-level to high-imp	edance output	See Figures 1 and 2		100	250	ns
	Rise time	Single ended			135	300	ns
tr	Rise une	Differential			90	180	ns
4.	Fall time	Single ended			145	300	ns
tf	Fair ume	Differential]		95	180	ns
+	Pulso skow Ita ta I	Single ended]		15	50	ns
^t sk(p)	Pulse skew, tpLH-tpHL	Differential	1		2	22	ns



SN75LBC775 SINGLE-CHIP APPLETALKTM AND LOCALTALKTM TRANSCEIVER

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RECEIVER

electrical characteristics over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	түр†	MAX	UNIT
VIT+	Positive-going differential input voltage threshold				200	mV
VIT-	Negative-going differential input voltage threshold \ddagger]	-200			mV
V _{hys}	Input voltage hysteresis (V _{IT+} – V _{IT-)}	$I_{OH} = 2 \text{ mA}, \qquad I_{OL} = -2\text{mA}, \qquad $ See Figure 4		30		mV
VOH	High-level output voltage		2	4.5		V
VOL	Low-level output voltage	1			0.8	V
	o	$V_{O} = 0$	8	50	85	mA
los	Short-circuit output current‡	VO = VCC	-85	-50	-8	mA
ri	Input resistance	V_{CC} = 0 or 5.25 V, $-12 \text{ V} \le \text{V}_{I} \le 12 \text{ V}$	6			kΩ

[†] All typical values are at V_{CC} = 5 V and T_A = 25°C.
[‡] The algebraic convention, in which the less positive (more negative) limit is designated minimum, is used in this data sheet.

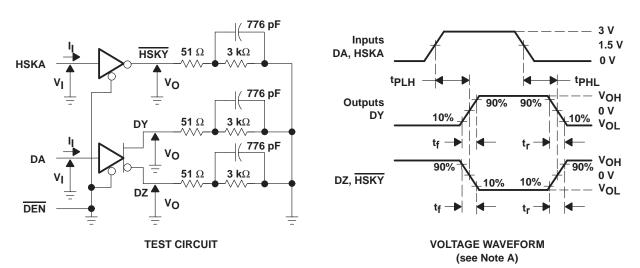
switching characteristics over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CON	NDITIONS	MIN	TYP†	MAX	UNIT
^t PHL	Propagation delay time, high- to low-level output				25	60	ns
^t PLH	Propagation delay time, low- to high-level output		0.45.55		22	60	ns
t _r	Rise time	$R_L = 2 k\Omega$, See Figure 4	C _L = 15 pF,		8	25	ns
t _f	Fall time				7	25	ns
^t SK(P)	Pulse skew, tpLH - tpHL				3	20	ns
tPZL	Receiver output enable time to low-level output				50		ns
^t PZH	Receiver output enable time to high-level output		Soo Eiguro 5		50		ns
^t PLZ	Receiver output disable time to low-level output	$\Box \Box = 00 \text{ pr},$	C _L = 80 pF, See Figure 5		50		ns
^t PHZ	Receiver output disable time to high-level output				50		ns

[†] All typical values are at $V_{CC} = 5$ V and $T_A = 25^{\circ}C$.

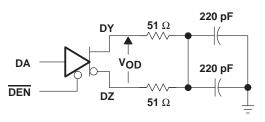


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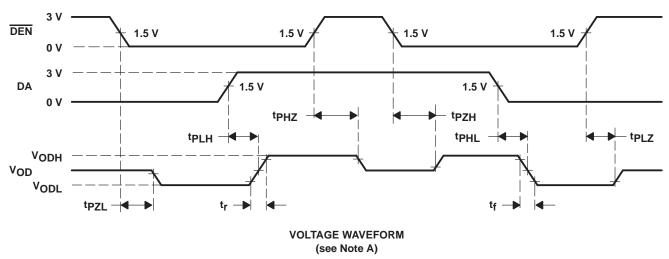


PARAMETER MEASUREMENT INFORMATION

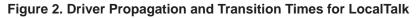






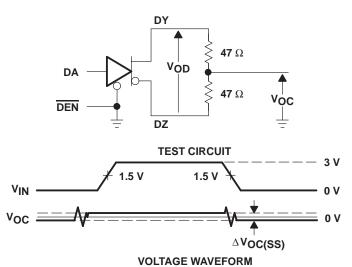


NOTE A: The input waveform t_f , $t_f < = 10$ ns



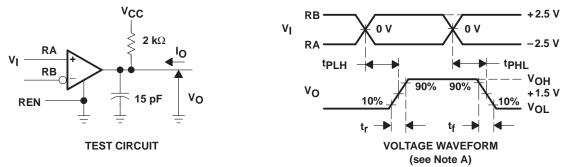


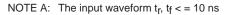
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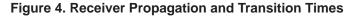


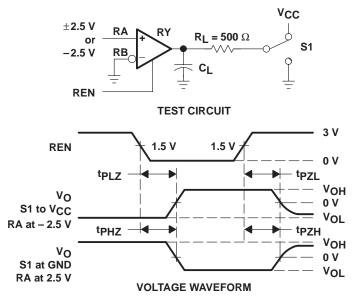
PARAMETER MEASUREMENT INFORMATION







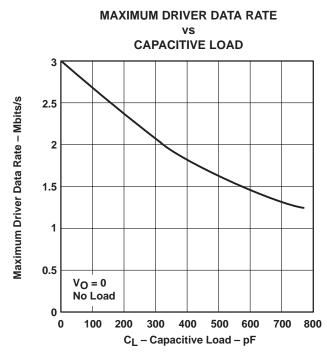








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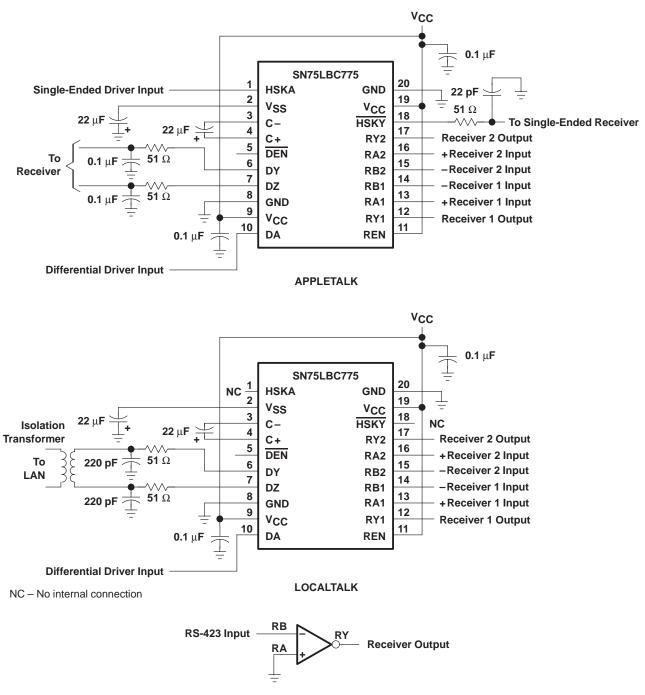


TYPICAL CHARACTERISTICS

Figure 6



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APPLICATION INFORMATION

Figure 7. Receiving RS-423 Signals With a Differential Receiver



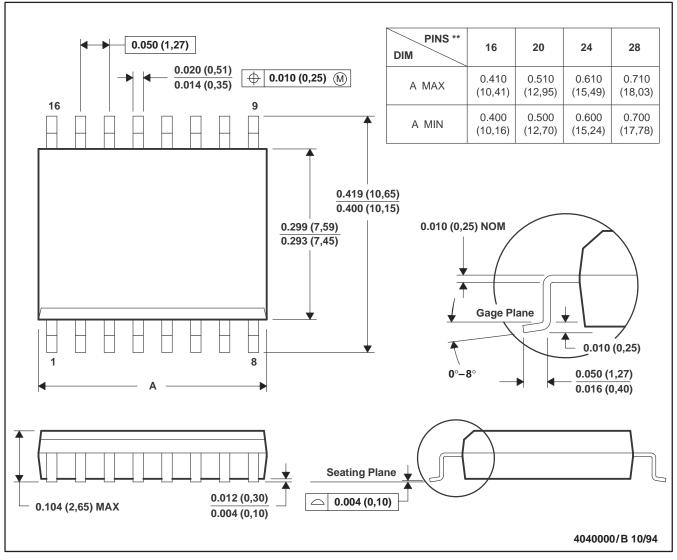
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MECHANICAL INFORMATION

DW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

16 PIN SHOWN



NOTES: B. All linear dimensions are in inches (millimeters).

C. This drawing is subject to change without notice.

D. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

E. Falls within JEDEC MS-013



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins I	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN75LBC775DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75LBC775DWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

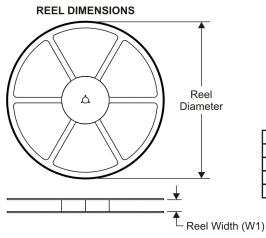
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

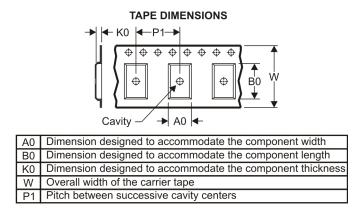
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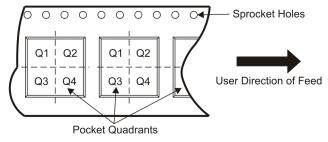
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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



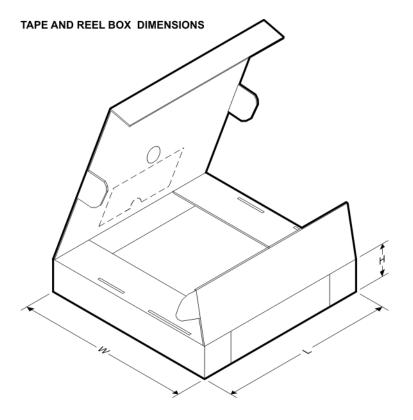
Device	Package	Package	Pine
*All dimensions are nominal			

Device		Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75LBC775DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.1	2.65	12.0	24.0	Q1



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75LBC775DWR	SOIC	DW	20	2000	346.0	346.0	41.0

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